



## DM-OLED192-670

2.7" 128 × 160 MONOCHROME  
GRAPHIC OLED DISPLAY MODULE  
-MCU,SPI, I2C

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## 1 Revision History

Date	Changes
2022-08-15	First release

## 2 Main Features

Item	Specification	Unit
Diagonal Size	1.92	inch
Display Mode	Passive Matrix OLED	-
Display Colors	Monochrome	Colors
Resolution	$128 \times 160$	pixel
Controller IC	SH1108	-
Interface	8080MCU、SPI、I2C	-
Active Area	$28.908 \times 39.34$	mm
Panel Dimension	$32.9 \times 46.55$	mm
Pixel Size	$0.206 \times 0.226$	mm
Pixel Pitch	$0.226 \times 0.246$	mm
Weight	TBD	g

### 3 Pin Description

#### 3.1 Panel Pin Description

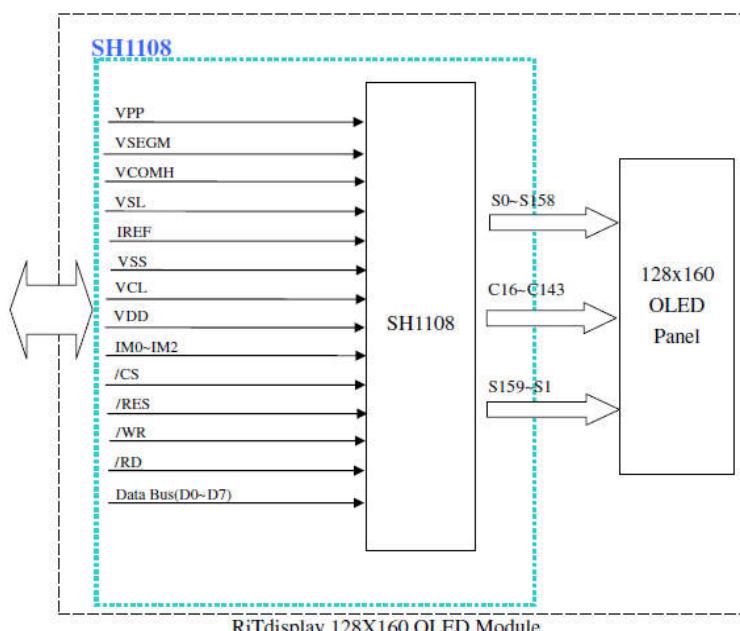
Pin No.	Symbol	Function Description	8080	SPI	IIC
1	NC(GND)	This is a reserved pin. It should be connected to VSS.			
2	VPP	Power supply for panel driving voltage.			
3	VSEGM	This is voltage output high level for segment pre-charge. A capacitor should be connected between this pin and VSS.			
4	VCOMH	This is voltage output high level for common signals. A capacitor should be connected between this pin and VSS.			
5	VSL	This is a segment voltage reference pin. A capacitor should be connected between this pin and VSS.			
6	NC	No connection			
7	IREF	This is a segment current reference pin. A resistor should be connected between this pin and VSS.			
8	VPP	Power supply for panel driving voltage.			
9	NC	No connection			
10	VSS	Ground pin.			
11	VCL	This is a common voltage reference pin. This pin should be connected to VSS externally			
12	VDD	Power supply for logic and input/output.			
13	IM0	This is MPU interface mode select pin.	Low	Low	Low
14	IM1	This is MPU interface mode select pin.	High	Low	High
15	VDD	Power supply for logic and input/output.			
16	IM2	This is MPU interface mode select pin.	High	Low	Low
17	/CS	This pin is the chip select input. When CS= "L", then the chip select becomes active, and data/command I/O is enabled.	CS#	CS#	Low
18	/RES	This is a reset signal input pin. When RES is set to "L", the settings are initialized.	/RES	/RES	/RES
19	A0	This is the Data/Command control pin that determines whether the data bits are data or a command. In I2C interface, this pin serves as SA0 to distinguish the different address of OLED driver.	A0	A0	A0
20	/WR	This is a MPU interface input pin. When connected to an 8080 MPU, this is active LOW. This pin connects to the 8080 MPU WR signal. The signals on the data bus are latched at the rising edge of the WR signal. When connected to a 6800 Series MPU: This is the read/write control signal input terminal. When R/W = "H": Read. When R/W = "L": Write.	/WR	Low	Low
21	/RD	This is a MPU interface input pin. When connected to an 8080 series MPU, it is active LOW. This pin is connected to the RD signal of the 8080 series MPU, and the data bus is in an output status when this signal is "L". When connected to a 6800 series MPU, this is active HIGH. This is used as an enable clock input of the 6800 series MPU.	/RD	Low	Low

22	D0	No connection	D0	SCL	SCL
23	D1	This is an 8-bit bi-directional databus that connects to an 8-bit or 16-bit standard MPU data bus.	D1	SI	SDA
24	D2	When the serial interface is selected, then D0 serves as the serial clock input pad	D2	Low	Low
25	D3	(SCL) and D1 serves as the serial data input pad (SI). At this time, D2 to D7 are set to high impedance.	D3	Low	Low
26	D4	When the I2C interface is selected, then D0 serves as the serial clock input pad (SCL) and D1 serves as the serial data input pad	D4	Low	Low
27	D5	(SDA). At this time, D2 to D7 are set to high impedance.	D5	Low	Low
28	D6		D6	Low	Low
29	D7		D7	Low	Low
30	VPP	Power supply for panel driving voltage.			

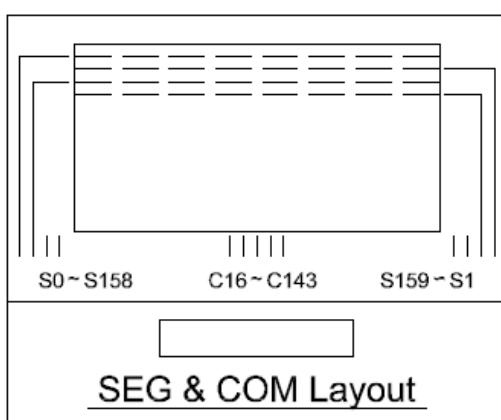
Note

- (1) Low is connected to VSS
- (2) High is connected to VDD

### 3.2 FUNCTION BLOCK DIAGRAM

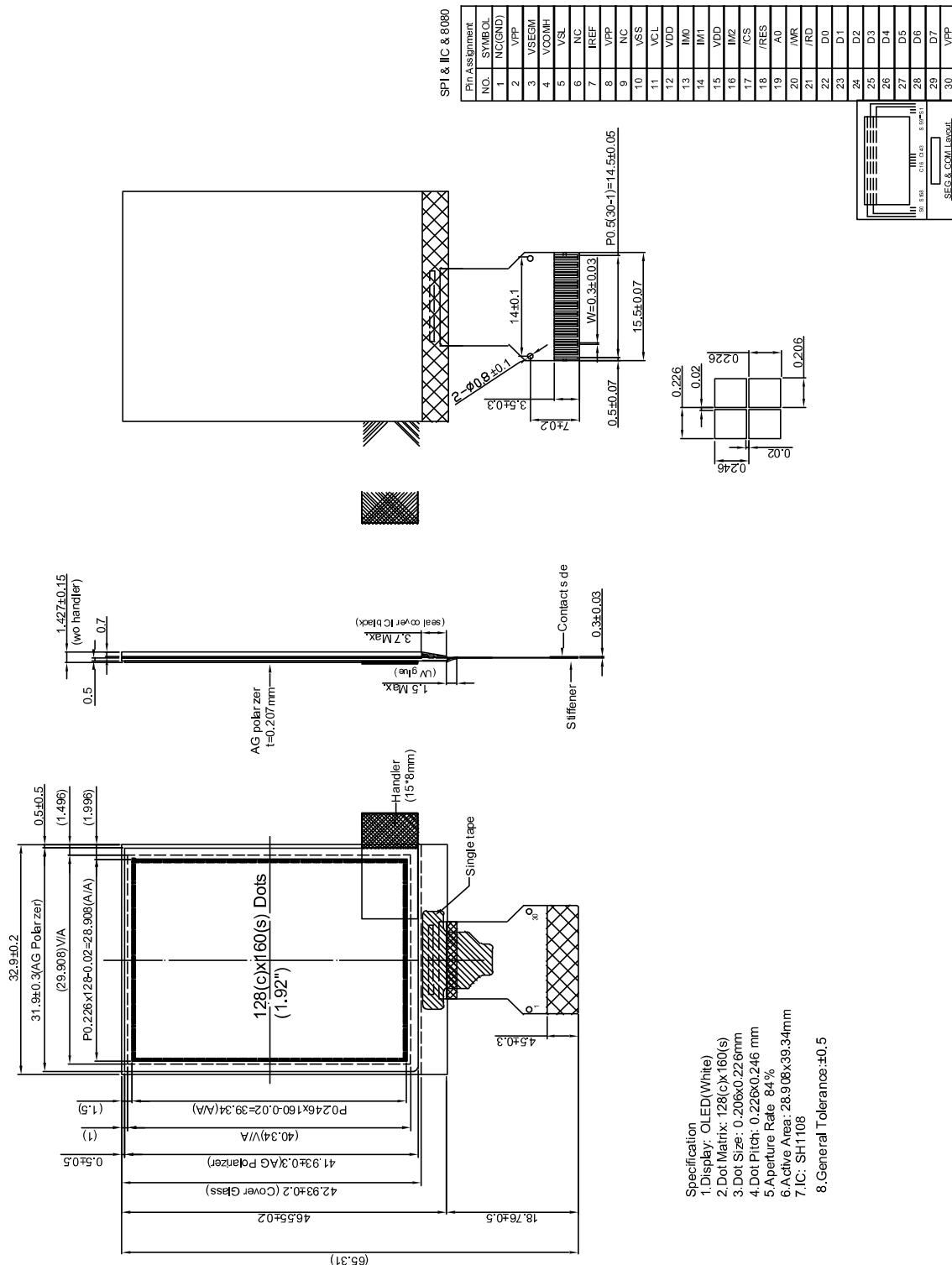


### 3.3 PANEL LAYOUT DIAGRAM



## 4 Mechanical Drawing

#### 4.1 Panel Mechanical Drawing



## 5 Optics & Electrical Characteristics

### 5.1 Optical Characteristics

Item	Min	Typ	Max	Unit	Remark
Normal mode current (IPP)	-	66	68	mA	All pixels on (1)
	-	16	17	mA	20% pixels on(1)
Standby mode current (IPP)	-	5	6	mA	Standby mode 10% pixels on (2)
	-	891	918	mW	All pixels on (1)
Normal mode power consumption	-	216	229.5	mW	20% pixels on (1)
	-	67.5	81	mW	Standby mode 10% pixels on (2)
IDD sleep mode current	-	-	5	uA	Sleep mode Current (3)
IPP sleep mode current	-	-	5	uA	Sleep mode Current (3)
Normal mode Luminance	115	145	-		Display Average
Standby Luminance	-	65	-		
View Angles	160	-	-	degree	
C.I.E (White)	0.32	0.36	0.40	-	C.I.E.1931
C.I.E(White)	0.34	0.38	0.42	-	C.I.E.1931
Response Time	-	10	-	μs	
Dark room Contrast	10000:1	-	-	-	

(1)Normal mode condition:

- Driving Voltage :13.5V
- Contrast setting :0xd0
- Frame rate :105Hz
- Duty setting :1/128

(2)Standby mode condition:

- Driving Voltage :13.5V
- Contrast setting :0x00
- Frame rate :105Hz
- Duty setting :1/128

(3)Sleep mode condition:

When send 0xae command OLED display off and memory data will be maintained.

(4)Wakeup condition:

When send 0xaf command OLED will be turned on.

## 5.2 LIFETIME SPECIFICATION

Parameter	Symbol	Min	Max	Unit	Remark
Supply Voltage	V <sub>DD</sub>	-0.3	3.6	V	Note 1,2
Supply Voltage	V <sub>PP</sub>	8	1	V	Note 1,2
Operating Temperature	T <sub>OP</sub>	-40	80	°C	-
Storage Temperature	T <sub>STG</sub>	-40	85	°C	-

Note:

(A)Under V<sub>PP</sub> = 13.5V,Ta= 25°C, 50%RH.

(B)Life timeis defined the amount of time when the luminance has decayed to less than 50% of the initial measuredluminance.

(1)Setting of 145 cd/m<sup>2</sup>:

-Contrast setting :0xd0

-Frame rate :105Hz

-Duty setting :1/128

(2)Setting of115cd/m<sup>2</sup>:

-Contrast setting :0x80

-Frame rate :105Hz

-Duty setting :1/128

## 5.3 Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Remark
Supply Voltage	V <sub>DD</sub>	-0.3	3.6	V	Note 1,2
Supply Voltage	V <sub>PP</sub>	8	1	V	Note 1,2
Operating Temperature	T <sub>OP</sub>	-40	80	°C	-
Storage Temperature	T <sub>STG</sub>	-40	85	°C	-

NNote:

(1)Maximum ratings are those values beyondwhich damages to the OLED module may occur. The OLED functional operation should be restricted tothe limits in the section 6. Electrical Characteristicstable.

(2)The defined temperature ranges do not include the polarizer. Themaximum

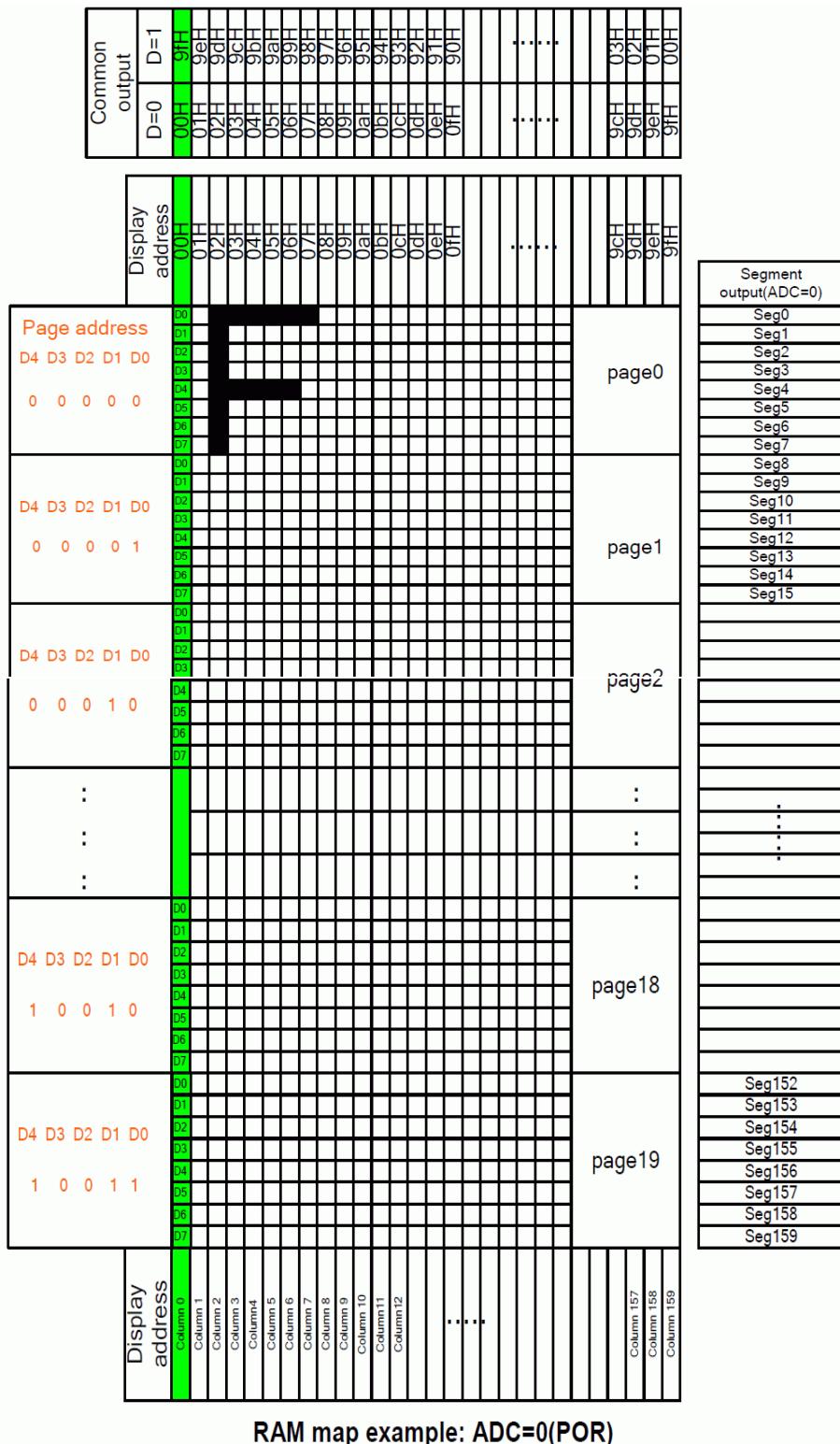
## 5.4 D.C ELECTRICALCHARACTERISTICS

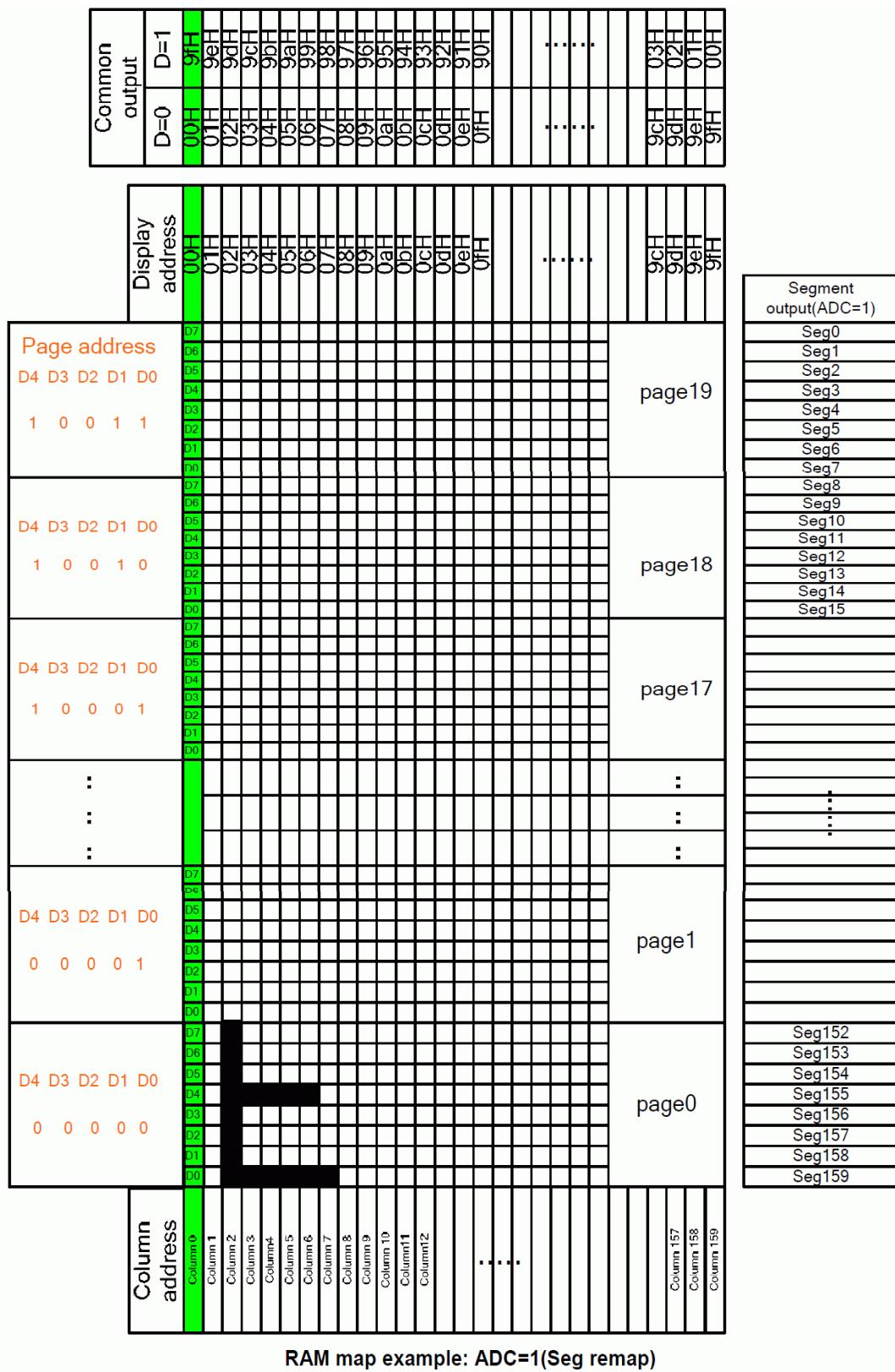
Item	Symbol	Condition	Min	Typ.	Max	Unit
Logic Supply Voltage for panel	V <sub>DD</sub>	-	1.65	2.85	3.5	V
Display Supply Voltage for panel	V <sub>PP</sub>	-	13	13.5	14	V
Low Level Input Voltage	V <sub>IL</sub>	-	V <sub>SS</sub>	-	0.2 x V <sub>DD</sub>	V
High Level Input Voltage	V <sub>IH</sub>	-	0.8 x V <sub>DD</sub>	-	V <sub>DD</sub>	V
Low Level Output Voltage	V <sub>OL</sub>	I <sub>OL</sub> =-0.5mA	V <sub>SS</sub>	-	0.2 x V <sub>DD</sub>	V
High Level Output Voltage	V <sub>OH</sub>	I <sub>OH</sub> =0.5mA	0.8 x V <sub>DD</sub>	-	V <sub>DD</sub>	V

Note: The V<sub>PP</sub> input must keep in a stable value; ripple and noise are not allowed.

## 6 INTERFACE

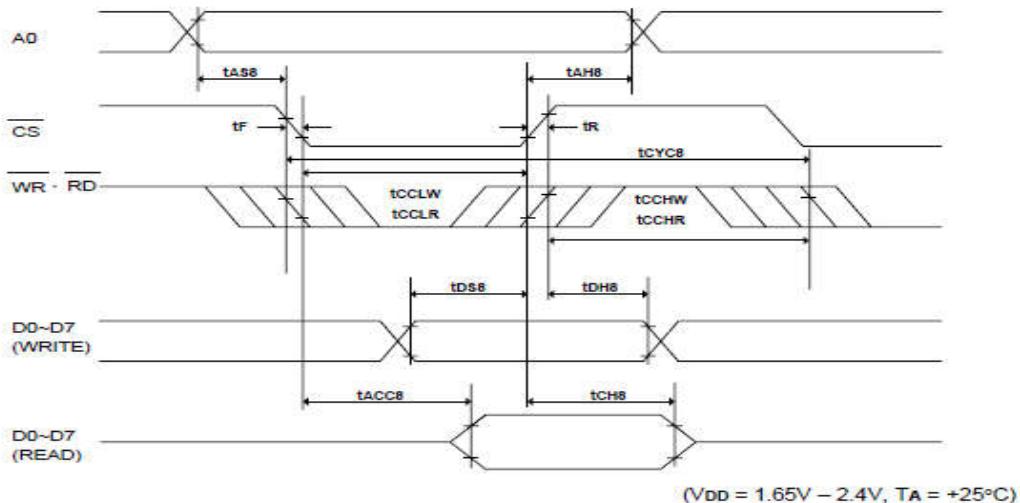
### 6.1 GRAPHIC DISPLAY DATA RAM ADDRESS MAP





## 6.2 INTERFACE TIMING CHART

System buses Read/Write characteristics (For the 8080 Series Interface MPU)



Symbol	Parameter	Min.	Typ.	Max.	Unit	Condition
tCYC8	System cycle time	300	-	-	ns	
tAS8	Address setup time	0	-	-	ns	
tAH8	Address hold time	0	-	-	ns	
tDS8	Data setup time	40	-	-	ns	
tDH8	Data hold time	30	-	-	ns	
tCH8	Output disable time	10	-	70	ns	CL = 100pF
tACC8	RD access time	-	-	280	ns	CL = 100pF
tCCLW	Control L pulse width (WR)	100	-	-	ns	
tCLR	Control L pulse width (RD)	120	-	-	ns	
tCCHW	Control H pulse width (WR)	100	-	-	ns	
tCHR	Control H pulse width (RD)	100	-	-	ns	
tR	Rise time	-	-	15	ns	
tF	Fall time	-	-	15	ns	

(VDD = 2.4V – 3.5V, TA = +25°C)

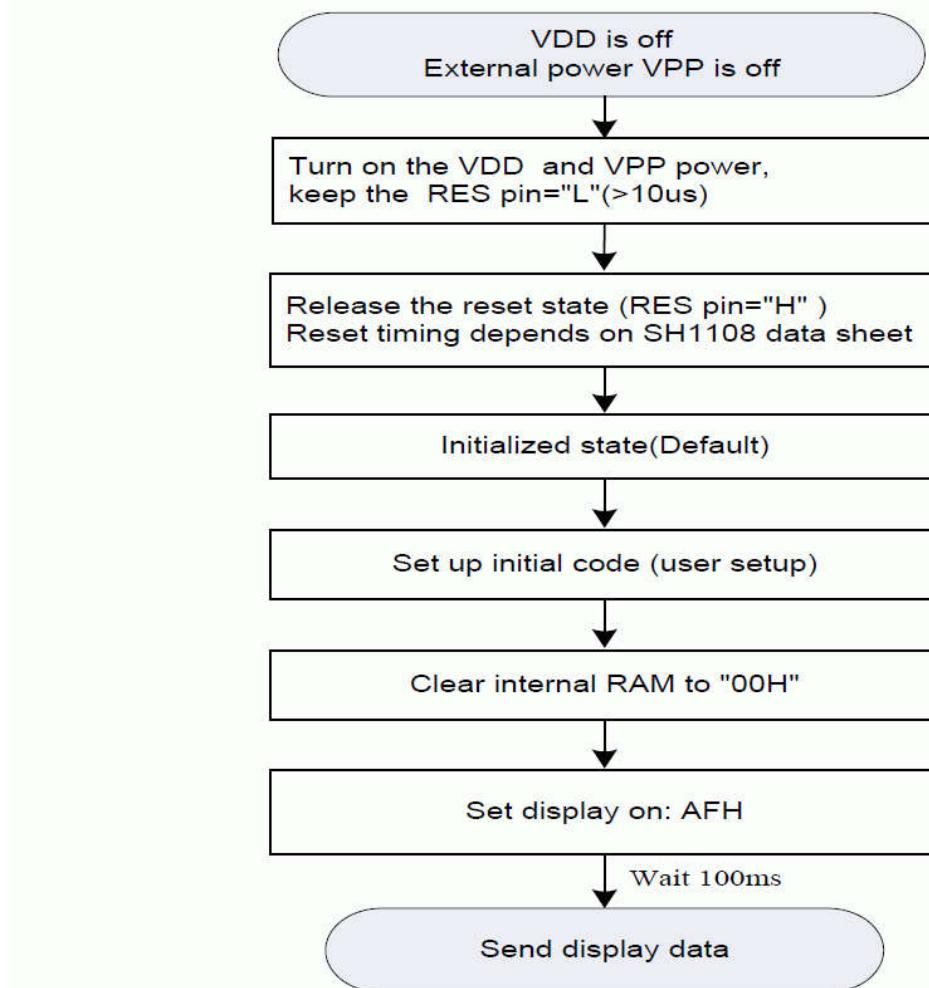
Symbol	Parameter	Min.	Typ.	Max.	Unit	Condition
t <sub>cyc8</sub>	System cycle time	300	-	-	ns	
t <sub>as8</sub>	Address setup time	0	-	-	ns	
t <sub>ah8</sub>	Address hold time	0	-	-	ns	
t <sub>ds8</sub>	Data setup time	40	-	-	ns	
t <sub>dh8</sub>	Data hold time	15	-	-	ns	
t <sub>ch8</sub>	Output disable time	10	-	70	ns	C <sub>L</sub> = 100pF
t <sub>acc8</sub>	RD access time	-	-	140	ns	C <sub>L</sub> = 100pF
t <sub>cclw</sub>	Control L pulse width (WR)	100	-	-	ns	
t <sub>cclr</sub>	Control L pulse width (RD)	120	-	-	ns	
t <sub>cchw</sub>	Control H pulse width (WR)	100	-	-	ns	
t <sub>cchr</sub>	Control H pulse width (RD)	100	-	-	ns	
t <sub>R</sub>	Rise time	-	-	15	ns	
t <sub>F</sub>	Fall time	-	-	15	ns	

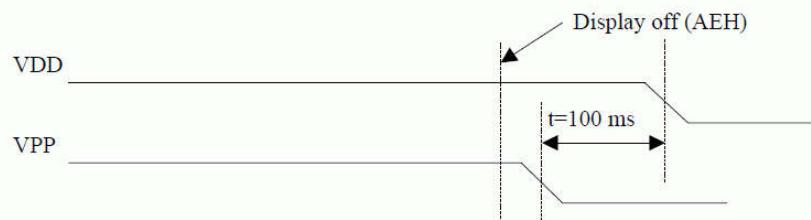
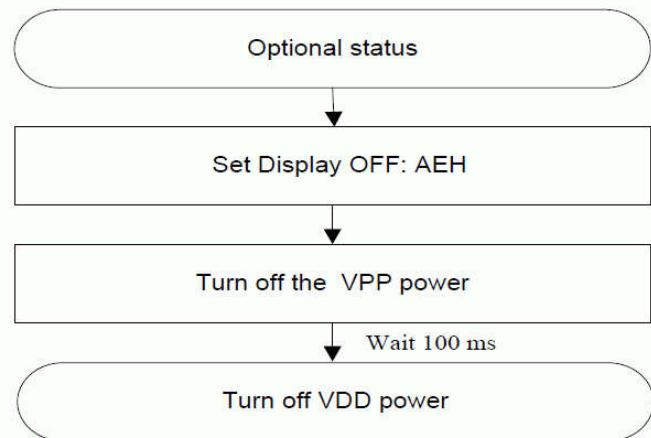
## 7 Power ON/OFF Sequence & Application Circuit

### 7.1 POWER ON / OFFSEQUENCE

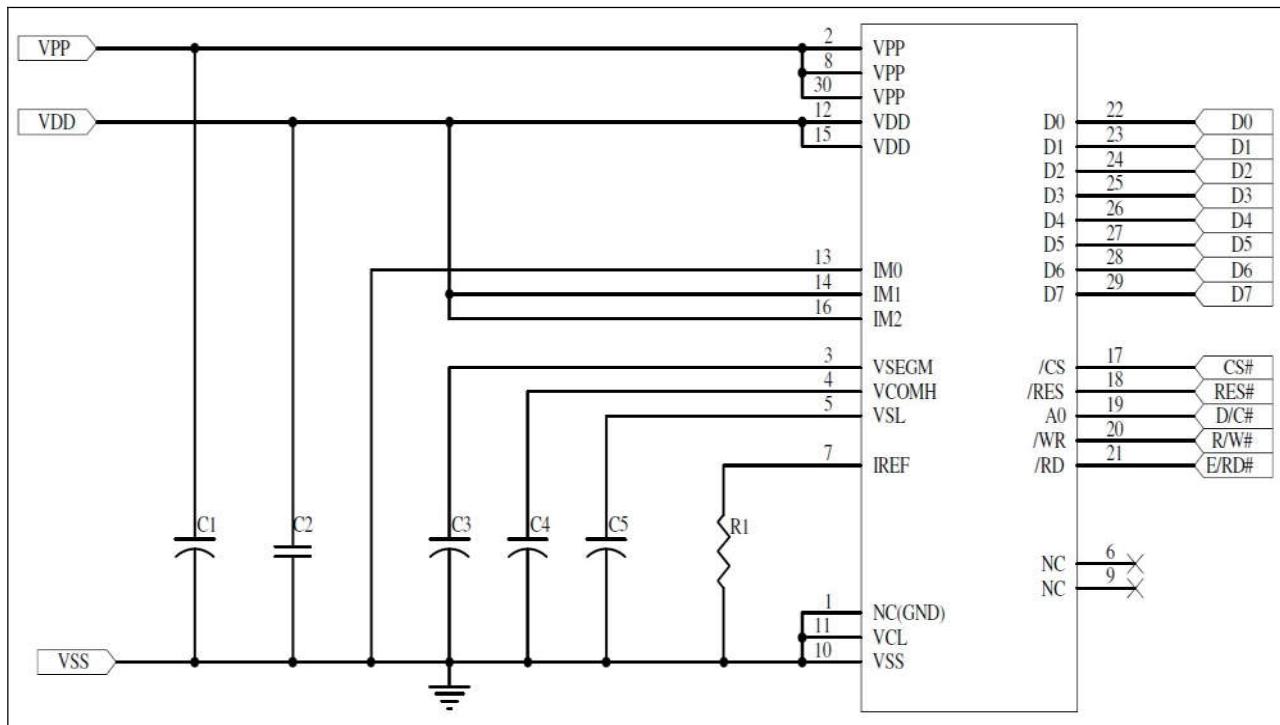
#### Power on sequence:

External power is being used immediately after turning on the power:



**Power off sequence:**

## 7.2 APPLICATION CIRCUIT



### Recommend components:

C1, C3,C4,C5: 4.7uF/25V VISHAY (572D475X0025A2T) or (Tantalum type)

C2: 1uF/6.3V(0603)

R1: 750K ohm (0603) 1%

**This circuit is for 8080 8bit interface.**

## 9.3 COMMAND TABLE

Refer to IC Spec.: SH1108G

## 8 Reliability

Test Item	Content of Test	Test Condition	Note
High Temperature Storage	Endurance test applying the high storage temperature for a long time.	85°C 240hrs	5
Low Temperature Storage	Endurance test applying the high storage temperature for a long time.	-40°C 120hrs	5
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 120hrs	5
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40°C 120hrs	5
High Temperature/ Humidity Operation	65°C, 90%RH, 120hrs	/	5
Thermal Shock Resistance	-40 ° C ~85 ° C (-40 ° C /30min; transit /3min; 85 ° C /30min; transit/3min) 1cycle: 66min, 100 cycles	/	1 Carton
Drop	Height: 120cm Sequence : 1 angle、3 edges and 6 faces Cycles: 1		1 Carton
ESD (Non-operation)	Air discharge model, ±8kV, 10times	/	5

Test and measurement conditions

1.All measurements shall not be started until the specimens attain to temperature stability.

2.The degradation of Polarizer are ignored for item 1, 4 &5.

Evaluation criteria

1.The function test isOK.

2.No observable defects.

3.Luminance: > 50% of initial value.

4.Current consumption: within±50% of initial value.

## 9 Warranty and Conditions

<http://www.displaymodule.com/pages/faq> HYPERLINK  
 "http://www.displaymodule.com/pages/faq"